



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# Microsemi<sup>®</sup>

## UM7000 / UM7100 / UM7200

### HIGH POWER PIN DIODES

RoHS Compliant Versions Available



## DESCRIPTION

The UM7000 and UM7100 series offer moderately high power handling in combination with reasonably low levels of both series resistance and capacitance. The UM7200 series offers the lowest series resistance, but the highest capacitance of the group. The differences in specified performance for each of the series, results from different I-region thickness. The three series have broad applicability in many RF and microwave switch and attenuator circuits. Additionally, the UM7100 in leaded versions is usually the most cost-effective diode choice in high volume usage.

### IMPORTANT:

For the most current data, consult MICROSEMI's website: [www.MICROSEMI.com](http://www.MICROSEMI.com)

## ABSOLUTE MAXIMUM RATINGS AT 25° C (UNLESS OTHERWISE SPECIFIED)

Package	Conditions	(P <sub>D</sub> ) Power Dissipation (W)	( $\theta$ ) Thermal Resistance (°C/W)
A	25 °C Pin Temperature	10	15V
B	½ in. total length to 25 °C Contact Free Air	5.5	27.5
E		1.5	
C	25 °C Stud Temperature	10	15
D	25 °C Stud Temperature	7.5	20
SM	25 °C End Cap Temperature	8	17
ALL	1 us pulse (Single)	100KW	60 kW 35 kW 20 kW
ALL	Storage Temperature (T <sub>OP</sub> )	-65 °C to + 175 °C	
ALL	Operating Temperature (T <sub>OP</sub> )	-65 °C to + 175 °C	

## KEY FEATURES

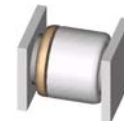
- Voltage ratings to 1000V (UM7000)
- Average power dissipation to 10 W
- Series resistance as low as 0.25  $\Omega$
- Carrier lifetime greater than 2.5  $\mu$ s
- Low capacitance
- Low conductance (High R<sub>p</sub>)
- Compatible with automated assembly
- RoHS compliant packaging Available<sup>1</sup>  
(Use UM7202B, etc.)

<sup>1</sup> The UM7000 series of products can be supplied with a RoHS compliant finish (UMX7000) or with a 90/10 Sn/Pb finish. Stud Packages C/CR/D/DR are supplied with a RoHS complaint Gold finish Consult factory for details.



## APPLICATIONS/BENEFITS

- Isolated stud package available
- Surface mount package available
- Soldering temperature: 260 °C for 10 seconds maximum



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**VOLTAGE RATINGS****@ 25°C (unless otherwise specified)**

Part Number			Reverse Voltage @ 10uA (V)
UM7001	UM7101	UM7201	100
UM7002	UM7102	UM7202	200
-	UM7104	UM7204	400
UM7006	-	-	600
-	UM7108	-	800
UM7010	-	-	1000

**ELECTRICAL PARAMETERS @ 25°C (unless otherwise specified)**

Parameter	Symbol	Conditions	UM7000	UM7100	UM7200	Units
Reverse Current (Max)	$I_R$	At rated voltage	10	10	10	uA
Series Resistance(Max)	$R_S$	$I_F = 100 \text{ mA}$ , $F = 100 \text{ MHz}$	1.0	0.6	0.25	Ohm
Capacitance (Max)	$C_T$	$V_R = 100 \text{ V}$ , $F = 1 \text{ MHz}$	0.9	1.2	2.2	pF
Parallel Resistance(Min)	$R_P$	$V_R = 100 \text{ V}$ , $F = 100 \text{ MHz}$	200k	150k	70k	Ohms
Carrier Lifetime(Min)	$T_L$	$I_F = 10 \text{ mA}$	2.5	2.0	1.5	uS
I-Region Width (Min)	W	-	150	80	40	um

See following pages for performance graphs and mechanical data.





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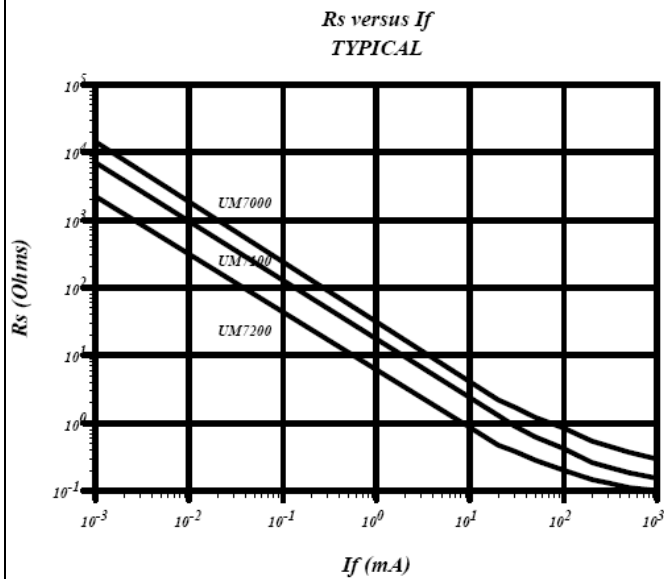
## UM7000 / UM7100 / UM7200

### HIGH POWER PIN DIODES

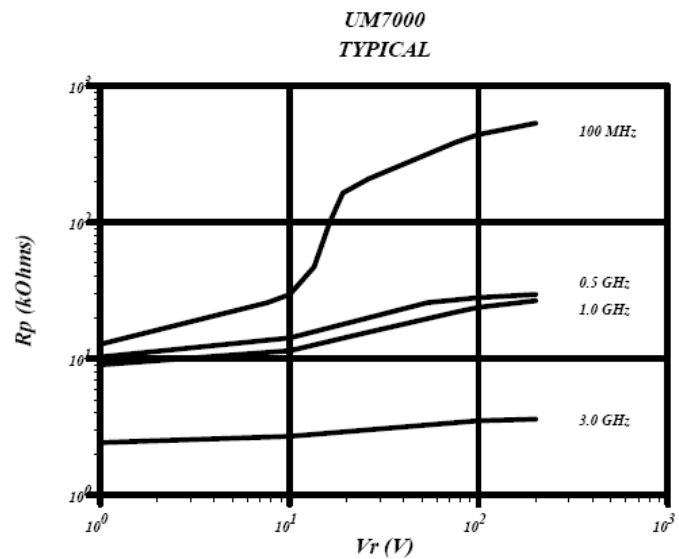
RoHS Compliant Versions Available



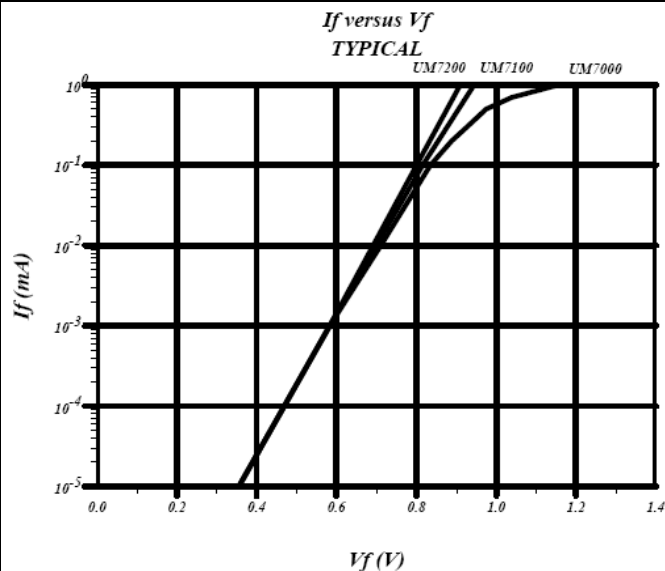
#### TYPICAL $R_S$ VS $I_F$



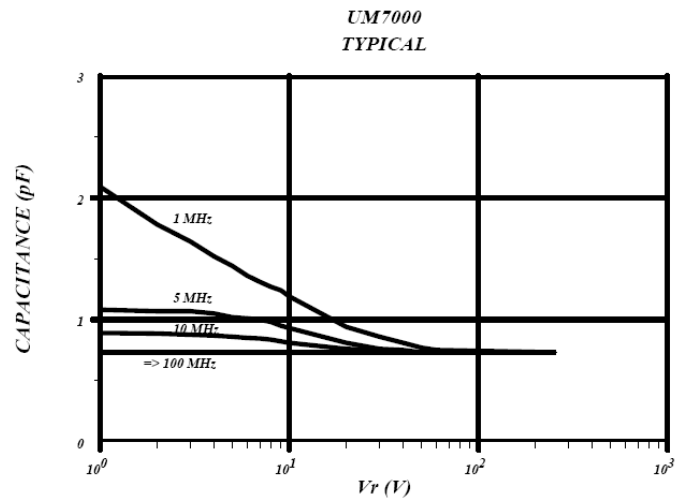
#### TYPICAL $R_P$ VS VOLTAGE



#### $I_F$ VS $V_F$



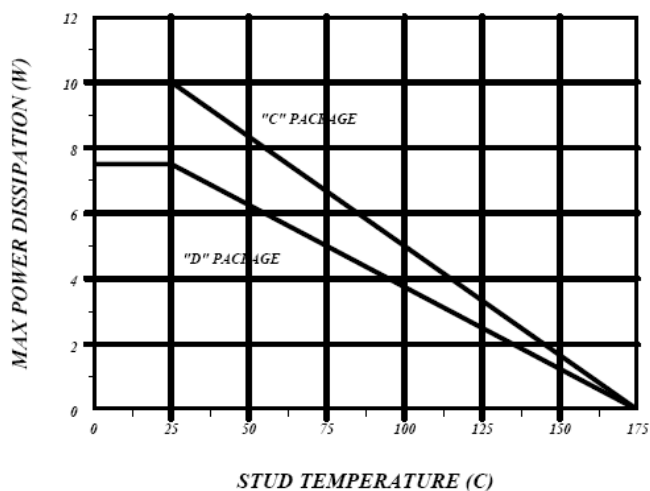
#### CAPACITANCE VS VOLTAGE





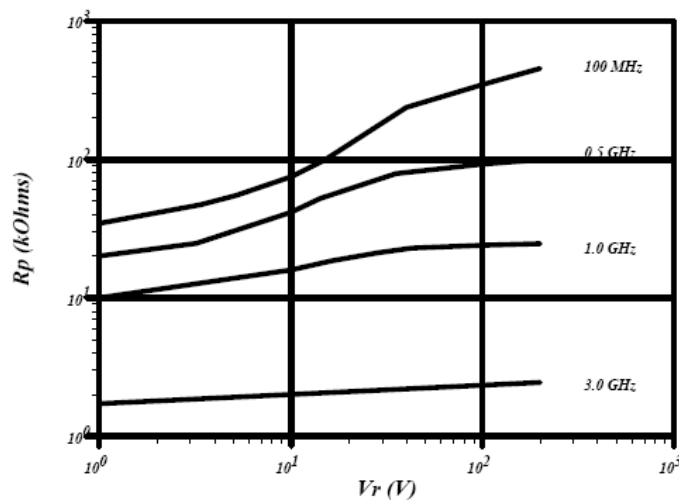
#### POWER RATING

POWER RATING STUD MOUNTED DIODES  
TYPICAL



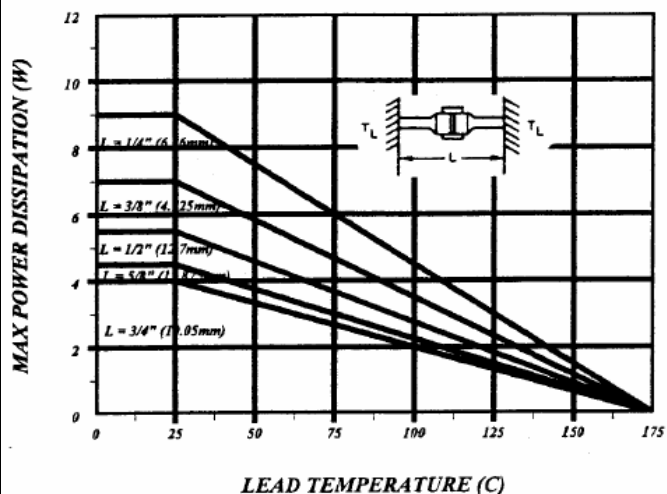
#### TYPICAL RP VS VOLTAGE

UM7100  
TYPICAL



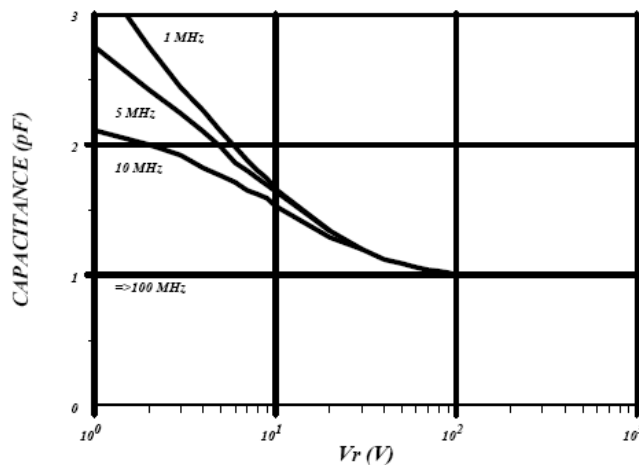
#### POWER RATING

POWER RATING AXIAL LEADED DIODES  
TYPICAL



#### CAPACITANCE VS VOLTAGE

UM7100  
TYPICAL





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## UM7000 / UM7100 / UM7200

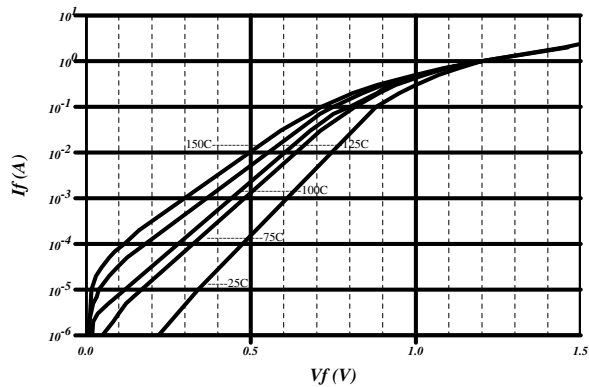
### HIGH POWER PIN DIODES

RoHS Compliant Versions Available



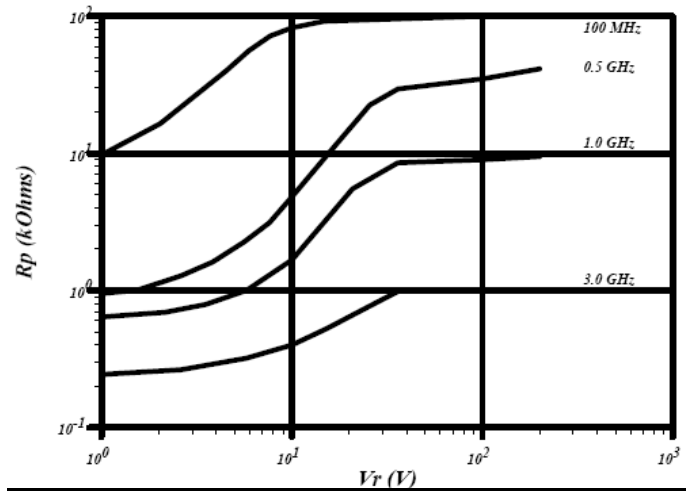
#### I/V VS TEMP

MEAN  $I_f$  VERSUS  $V_f$  CURVE VERSUS TEMPERATURE  
TYPICAL



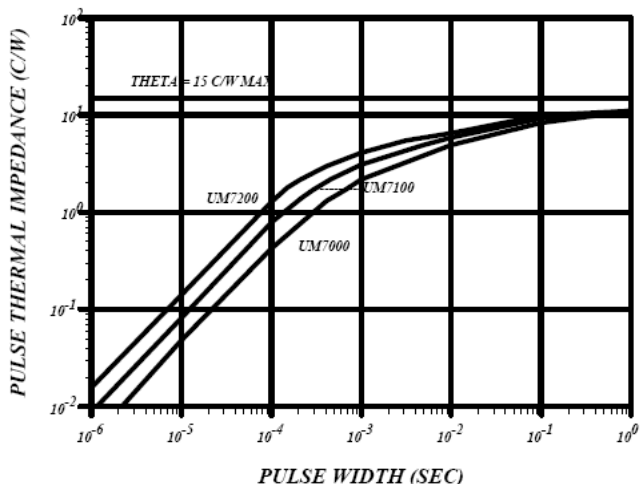
#### TYPICAL $R_p$ VS VOLTAGE

UM7200  
TYPICAL



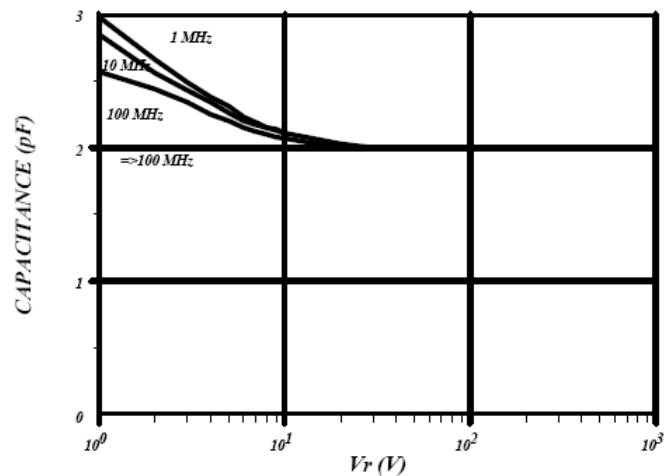
#### THERMAL IMPEDANCE

PULSE THERMAL IMPEDANCE VERSUS WIDTH  
TYPICAL



#### CAPACITANCE VS VOLTAGE

UM7200  
TYPICAL





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## UM7000 / UM7100 / UM7200

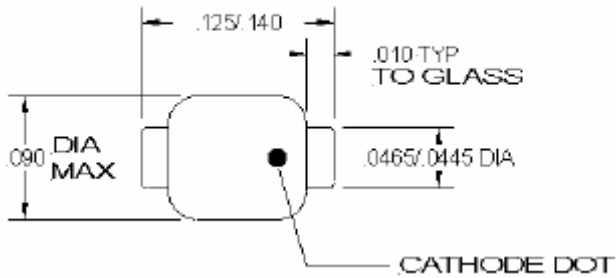
### HIGH POWER PIN DIODES

RoHS Compliant Versions Available



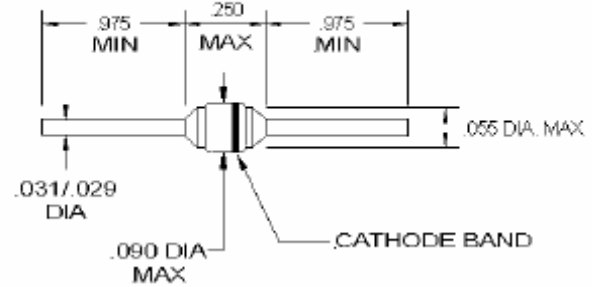
#### PACKAGE STYLE 'A'

##### STYLE "A"



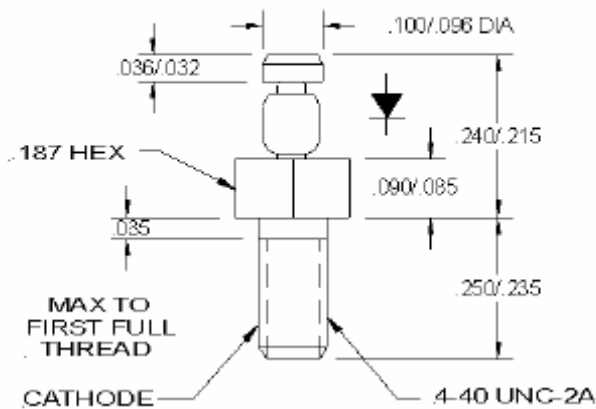
#### PACKAGE STYLE 'B'

##### STYLE "B"



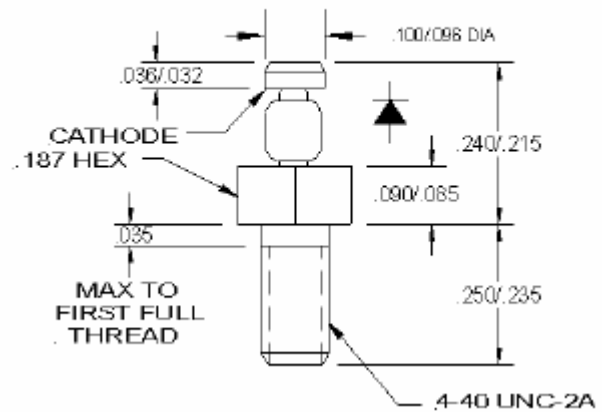
#### PACKAGE STYLE 'C'

##### STYLE "C"

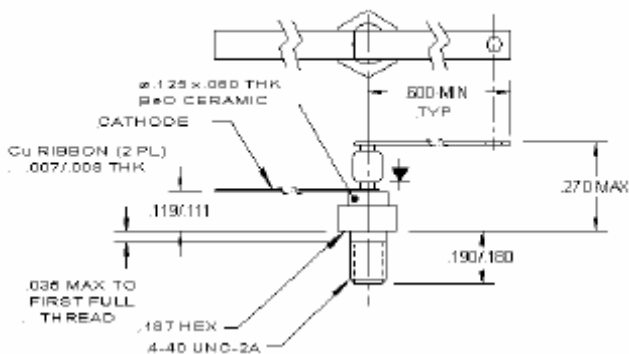


#### PACKAGE STYLE 'CR'

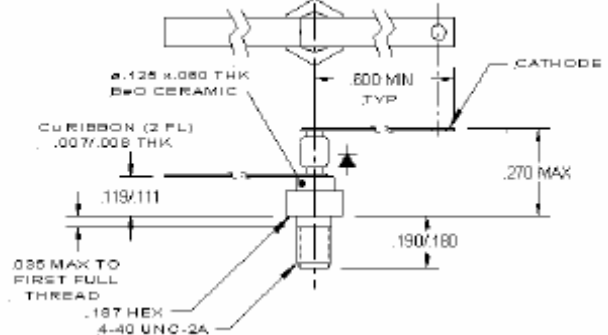
##### STYLE "CR"



#### PACKAGE STYLE 'D'



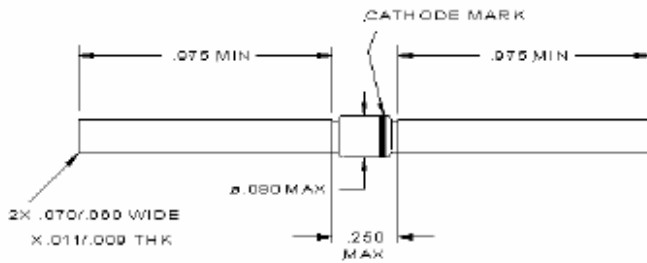
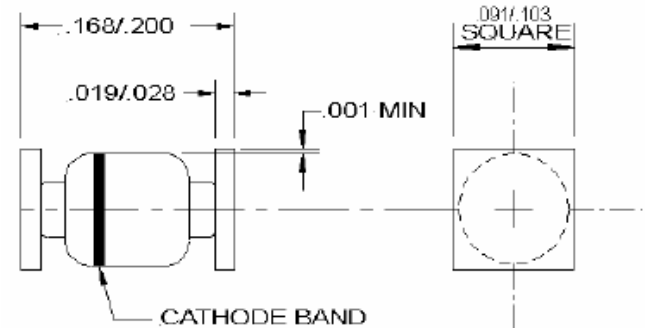
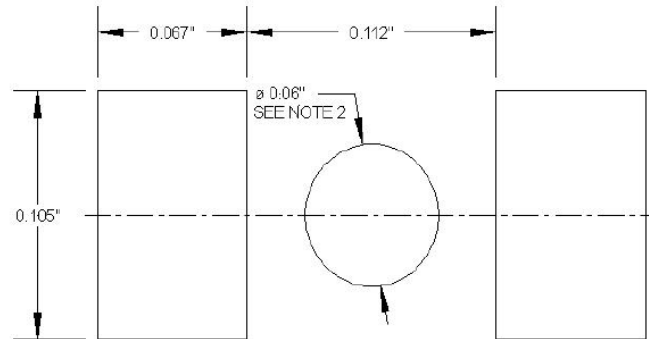
#### PACKAGE STYLE 'DR'



www.microsemi.com

MECHANICAL

RoHS Compliant Versions Available


**PACKAGE STYLE 'E'**

**PACKAGE STYLE 'SM'**

**STYLE 'SM' FOOTPRINT**

**NOTES:**

- 1 These dimensions will match the terminals and provide for additional solder fillets at the outboard ends at least as wide as the terminals themselves, assuming accuracy of placement within 0.005"
- 2 If the mounting method chosen requires use of an adhesive separate from the solder compound, a round (or square) spot of cement as shown should be centrally located.